

Applicant : Kouji Seki et al.
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Amendments to the Specification:

Please add the following new section before the Background at page 1, line 1:

CROSS REFERENCE TO RELATED APPLICATIONS

This application is a continuation of U.S. Patent Application entitled "Recognition Device, Bonding Device, and Method of Manufacturing a Circuit Device," filed 6/24/2002, Application Serial No. 10/178,506 which is incorporated herein by reference in its entirety.